

Computational Models in the Materials World - We are nearly there....



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Engineering Materials Today

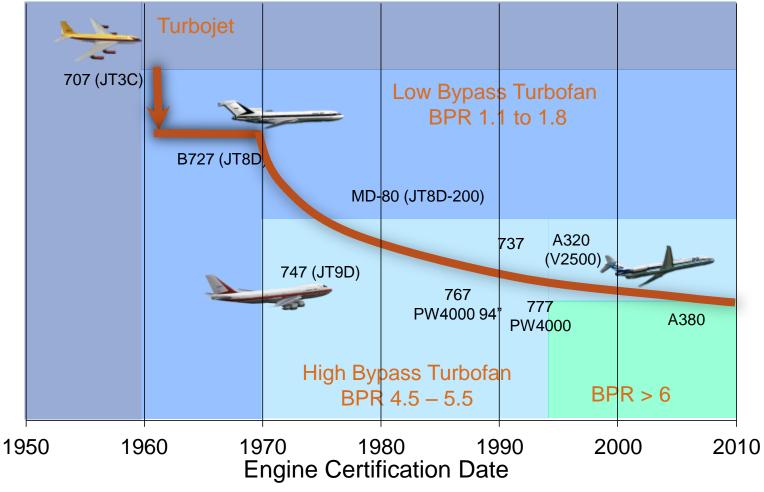


- Materials are critical for every engineered product
- Traditionally materials were developed by trial and error processes, separate from application requirements
- Materials are currently defined by static specifications based on empirical data
- Challenge and opportunity of Computational Materials Engineering is the linking of Materials, Manufacturing Processes and Component Designs

Evolution of System Efficiency







Propulsion History



Propulsion Innovations Enabled by Materials and Processing Technology



DS blades, Cast &Wrought disks, 1st Gen Thermal Spray TBC coatings



LFW Ti IBR, Dual Property Ni Disk, TBC blades, Burn resistant Ti, CatArc Metallic Coatings



1st Gen SC blades, 1st Gen PM disk, 1st Gen EB-PVD TBC



Dual Property 3rd Gen PM disk, High modulus blade, 2nd Gen TBC coating



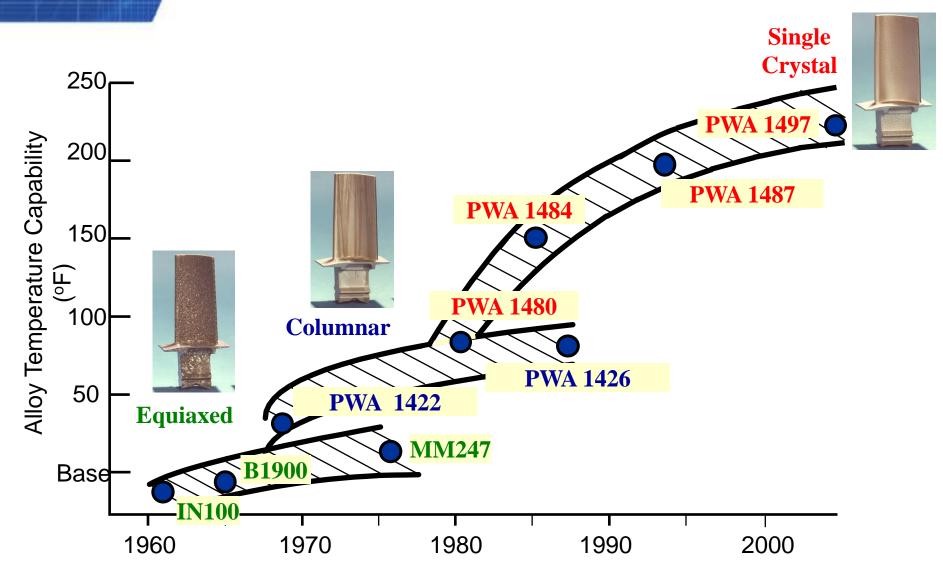
2nd Gen SC blades, Aluminide coatings, 2nd Gen PM/fracture tolerant disk



4th Gen PM disk alloy, Hybrid metallic airfoils, 3rd Gen TBC

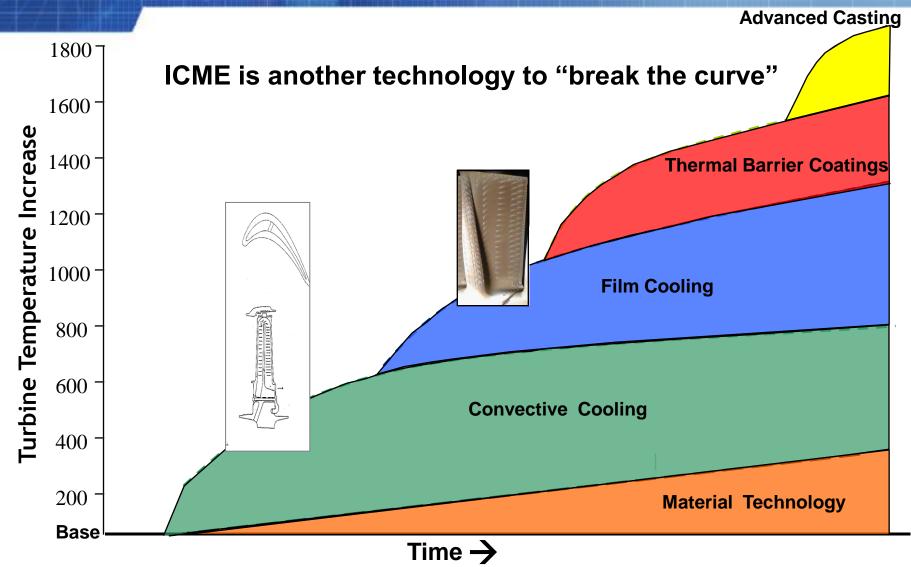
Ni Superalloy Turbine Airfoils: Significant Advances in Alloys and Casting Processes





Key Technology Advances for Turbine Airfoil Materials





Materials & Product Engineering

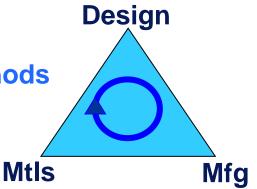


<u>Mechanical Properties</u> = fn (chemistry and microstructure)

<u>Microstructure</u> = fn (chemistry and processing)

<u>Processing</u> = fn (component geometry)

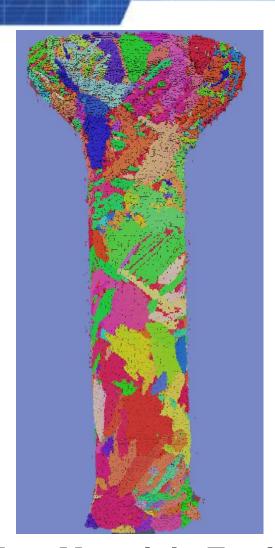
Materials, Manufacturing Methods and Component Design are Strongly Coupled

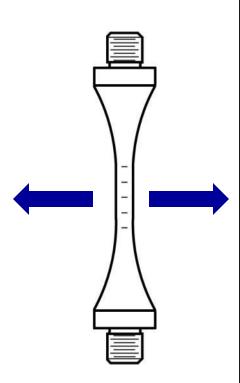


ICME -Integrated Computational Materials Engineering

What a Tensile Test Looks Like.....







MIL-HBK-5H

Table 5.4.1.0(b). Desig	ın Med	chanic	al and	Physic	al Prope	erties of Ti	-6AI-4V	Sheet, St	rip, and
Specification	AMS 4911 and MIL-T-9046, Comp. AB-1			MIL-T-9046, Comp. AB-1					
Form	Sheet		P1ate			Sheet, strip, and plate			
Condition			Annealed			Solution treated and aged			
Thickness, in.	≤ 0.1875		0.1875-2.000		2.001- 4.000	≤ 0.1875	0.1875- 0.750	0.751- 1.000	1.001- 2.000
Basis	A	В	A	В	S	S	S	S	S
Mechanical Properties: F _{tt} , ksi:									
L	134 134	139 139	130 ^a 130 ^a	135 138	130 130	160 160	160 160	150 150	145 145
LLT	126 126	131 131	120 120ª	125 131	120 120	145 145	145 145	140 140	135 135
F _{cp} , ksi: L LT	133 135	138 141	124 130	129 142	124 130	154 162	150	145	
F_{su} , ksi	87	90	79	84	79	100	93	87	
(e/D = 1.5)	213 ^b 272 ^b	221 ^b 283 ^b	206 ^b 260 ^b	214 ^b 276 ^b	206 ^b 260 ^b	236 286	248 308	233 289	
(e/D = 1.5)	171 ^b 208 ^b	178 ^b 217 ^b	164 ^b 194 ^b	179 ^b 212 ^b	164 ^b 194 ^b	210 232	210 243	203 235	
e, percent (S-basis): LLT	8°		10 10		10 10	5 ^d	8	6 6	6 6
E, 10 ³ ksi E _ω 10 ³ ksi G, 10 ³ ksi μ	16.0 16.4 6.2 0.31								
Physical Properties: ω, lb/in. ³									

a The rounded T_{99} values are higher than specification values as follows: $F_m(L) = 131 \text{ ksi}$, $F_m(LT) = 132 \text{ ksi}$, and $F_9(LT) = 123 \text{ ksi}$.

To a Materials Engineer

To a Mechanical Engineer

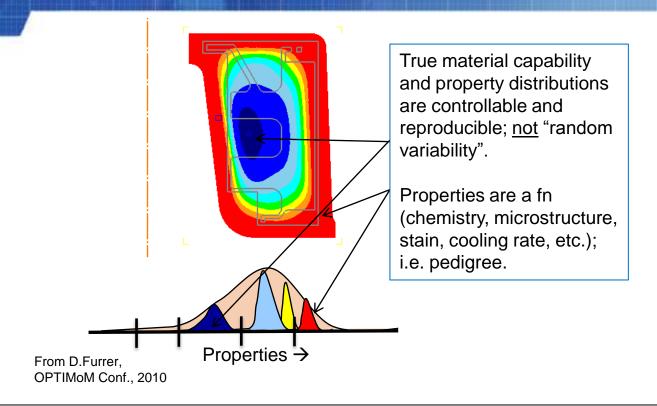
b Bearing values are "dry pin" values per Section 1.4.7.1.

c 8%-0.025 to 0.062 in. and 10%-0.063 in. and above

d 5%-0.050 in. and above; 4%-0.033 to 0.049 in. and 3%-0.032 in. and below

Materials Capability Definitions





Materials properties are path dependent and are often "location-specific". Engineering specifications often treat entire material volume as single, homogeneous property capabilities.

Modeling and simulation can belo enhanced.

Modeling and simulation can help enhance component property capability definitions

Traditional Materials Definitions



- Design Curves Empirical; Data Driven
- Specifications
- Prints Notes
- Fixed Process Requirements

Requires Defining Material Equivalency and Methods to Differentiate Material of One Control Pedigree from Another

The Challenge: Need Models and Computational Infrastructure



Current materials definitions for design limit design flexibility and final component capabilities

There is a need for:

Model-Based Materials Definitions

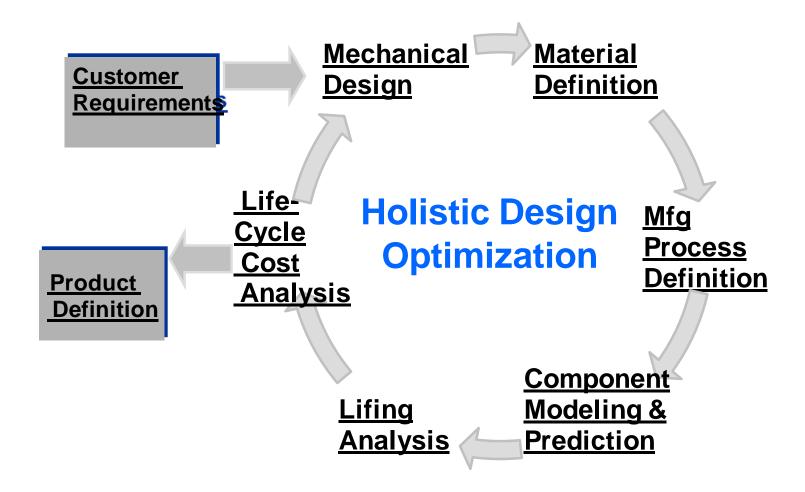
Model-based material definitions enable locationspecific prediction, analysis and optimization

Model-based materials definitions enable greater material, process and component definitions

Goal is prediction and control of capabilities

ICME Involved Linkage with Other Discipline Activities

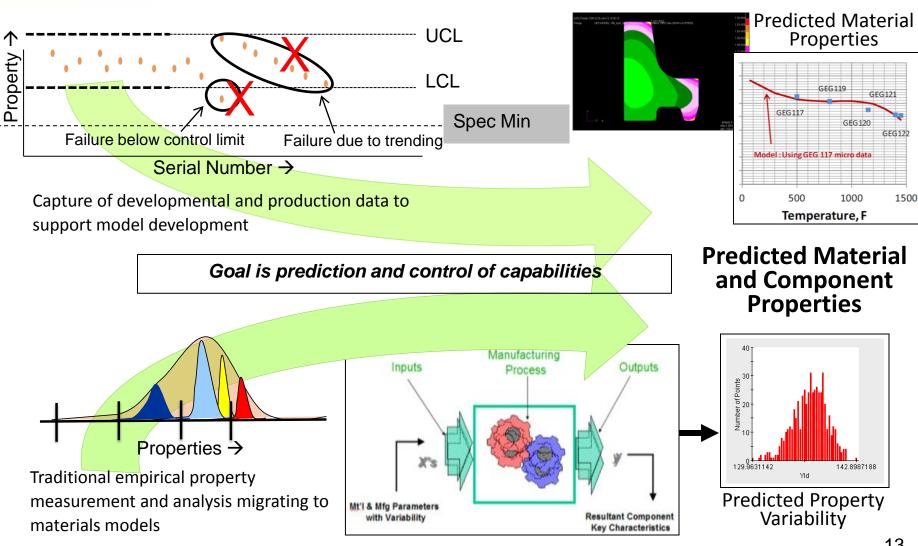




Materials Technology Enablers Pratt & Whitney



Computational Models and Advanced Data Management



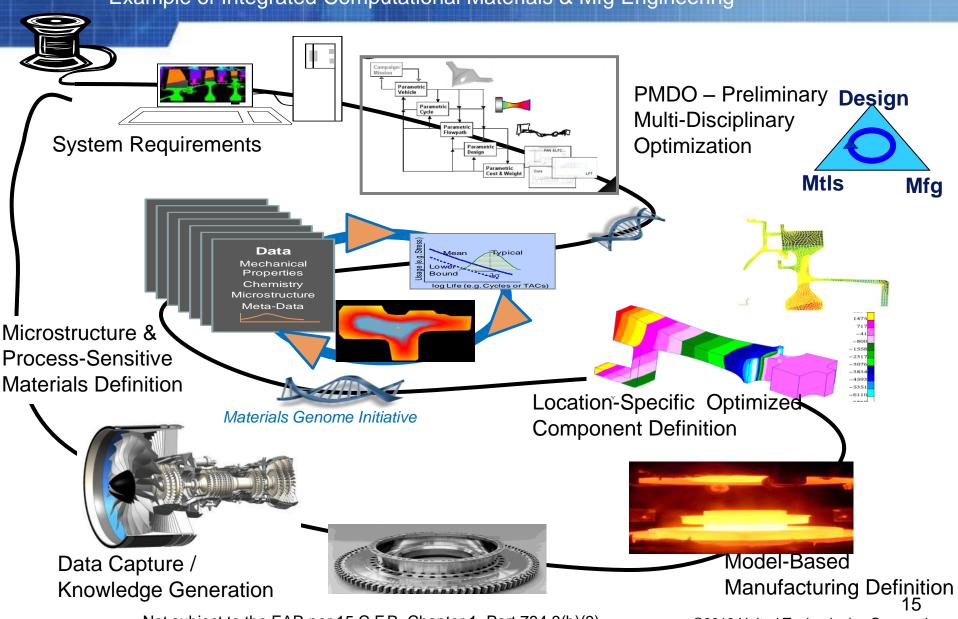
Material & Process Modeling Goals ** Pratt & Whitney

- Develop Simulation Tools that Emulate Reality
- Develop Analytical Tools that Provide Insight in Material - Process - Property Relationships
- Implement Tools for Design and Manufacturing Benefits
 - Model-based Decisions
 - Tangible Improvements obtained based on Decisions

Holistic Integration: Digital Thread



Example of Integrated Computational Materials & Mfg Engineering

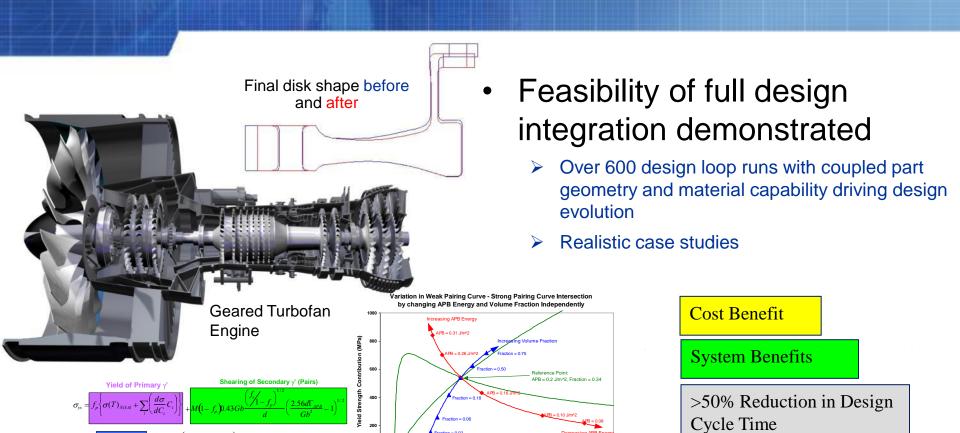


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Example of ICME Application





Case Study	Heat Treat	Forging	Part	Forge Wt	Part Wt	Burst Speed	Comments
1	Constant	Variable	Variable	-18%	-15%	+6%	Current State of the Art
2	Variable	Variable	Constant	-11%	n/a	+12%	Final Part shape constrained
3	Variable	Variable	Variable	-21%	-19%	+19%	Full impact of tool

Disciplines Touched by ICMSE



Integration of Computational Materials Science and Engineering is Complicated

- Materials
- Manufacturing
- Design
- Structures
- Quality
- Supply-Chain

Challenges to Effective ICME Deployment



- Accurate computational models
- Efficient simulation software tools
- Data and databases for model application
- Industry standard methods and protocols
- Computational methods for design linkages
- Well trained interdisciplinary workforce

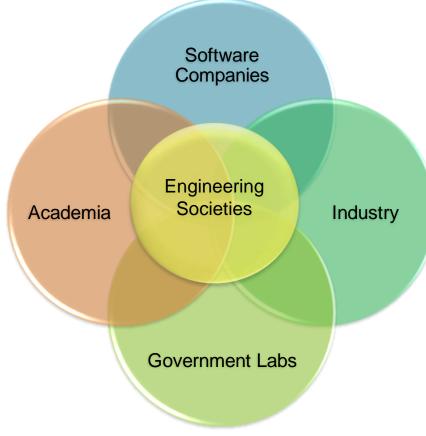
Unique engineering skill sets are required to support each challenge

Computational Supply-Chain



A series of well-established, capable and viable organizations that provide necessary portions of the ICME Value Chain

- Fundamental Model Development
- Model Integration into Software Packages
- Maintenance of Software Tools
- Database Generation
- Application Engineering
- Customer Approval and Certification
- Education and Training



Conclusions



- ICME: Potential for dramatic changes to development time, cost, and product capabilities
- Computational materials engineering enables virtual manufacture and component testing for optimization and risk mitigation
- Application of ICME has several challenges: trained practitioners; tools and methods; and computational infrastructure



Any Questions?

